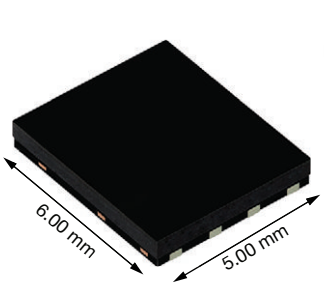
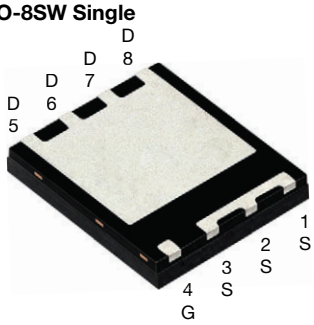
N-Channel 40 V (D-S) MOSFET

PowerPAK® SO-8SW Single



Top View



Bottom View

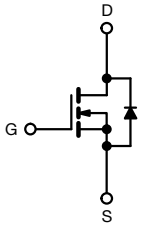
FEATURES

- TrenchFET® Gen IV power MOSFET
- Very low R_{DS} x Q_g figure-of-merit (FOM)
- Leadership $R_{DS(on)}$ minimizes power loss from conduction
- 100 % R_g and UIS tested
- Enhance power dissipation and lower R_{thJC}
- Wettable flank to improved solderability
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT
HALOGEN FREE

APPLICATIONS

- Synchronous rectification
- DC/DC converters
- OR-ing and hot swap switch
- Power supplies
- Motor drive control
- Battery management



N-Channel MOSFET

PRODUCT SUMMARY	
V_{DS} (V)	40
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.00058
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.00092
Q_g typ. (nC)	91
I_D (A) [a]	471
Configuration	Single

ORDERING INFORMATION	
Package	PowerPAK SO-8SW
Lead (Pb)-free and halogen-free	SiRS4400EPW-T1-RE3

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	40	V
Gate-source voltage		V_{GS}	± 20	
Continuous drain current (T_J = 150 °C)	T_C = 25 °C	I_D	471	A
	T_C = 70 °C		394	
	T_A = 25 °C		95 [b, c]	
	T_A = 70 °C		79 [b, c]	
Pulsed drain current (V_{GS} = 10 V, t = 100 µs)		I_{DM}	800	
Continuous source-drain diode current	T_C = 25 °C	I_S	187	
	T_A = 25 °C		7.6 [b, c]	
Single pulse avalanche current	L = 0.1 mH	I_{AS}	65	
Single pulse avalanche energy		E_{AS}	211	mJ
Maximum power dissipation	T_C = 25 °C	P_D	205	W
	T_C = 70 °C		144	
	T_A = 25 °C		8.3 [b, c]	
	T_A = 70 °C		5.8 [b, c]	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +175	°C
Soldering recommendations (peak temperature) [c]			260	

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient [b]	t ≤ 10 s	R_{thJA}	14	18	°C/W
Maximum junction-to-case (drain)	Steady state	R_{thJC}	0.53	0.73	

Notes

a. T_C = 25 °C
b. Surface mounted on 1" x 1" FR4 board
c. t = 10 s
d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
f. Maximum under steady state conditions is 50 °C/W

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SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static						
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 µA	40	-	-	V
V_{DS} temperature coefficient	$\Delta V_{DS}/T_J$	I_D = 10 mA	-	23	-	mV/°C
$V_{GS(th)}$ temperature coefficient	$\Delta V_{GS(th)}/T_J$	I_D = 250 µA	-	-7.1	-	
Gate-source threshold voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA	1.1	-	2.3	V
Gate-source leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I_{DSS}	V_{DS} = 40 V, V_{GS} = 0 V	-	-	1	µA
		V_{DS} = 40 V, V_{GS} = 0 V, T_J = 55 °C	-	-	10	
Drain-source on-state resistance [a]	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 20 A	-	0.00046	0.00058	Ω
		V_{GS} = 4.5 V, I_D = 20 A	-	0.00071	0.00092	
Forward transconductance [a]	g_{fs}	V_{DS} = 15 V, I_D = 30 A	-	130	-	S
Dynamic [b]						
Input capacitance	C_{iss}	V_{DS} = 20 V, V_{GS} = 0 V, f = 1 MHz	-	11 322	-	pF
Output capacitance	C_{oss}		-	3652	-	
Reverse transfer capacitance	C_{rss}		-	349	-	
Total gate charge	Q_g	V_{DS} = 20 V, V_{GS} = 10 V, I_D = 20 A	-	187	281	nC
		V_{DS} = 20 V, V_{GS} = 4.5 V, I_D = 20 A	-	91	137	
Gate-source charge	Q_{gs}		-	34	-	
Gate-drain charge	Q_{gd}		-	31	-	
Output charge	Q_{oss}	V_{DS} = 20 V, V_{GS} = 0 V	-	125	-	
Gate resistance	R_g	f = 1 MHz	0.28	1.4	2.8	Ω
Turn-on delay time	$t_{d(on)}$	V_{DD} = 20 V, R_L = 2 Ω, I_D ≅ 10 A, V_{GEN} = 10 V, R_g = 1 Ω	-	20	40	ns
Rise time	t_r		-	22	45	
Turn-off delay time	$t_{d(off)}$		-	73	150	
Fall time	t_f		-	25	50	
Turn-on delay time	$t_{d(on)}$	V_{DD} = 20 V, R_L = 2 Ω, I_D ≅ 10 A, V_{GEN} = 4.5 V, R_g = 1 Ω	-	86	170	
Rise time	t_r		-	142	285	
Turn-off delay time	$t_{d(off)}$		-	69	140	
Fall time	t_f		-	45	90	
Drain-Source Body Diode Characteristics						
Continuous source-drain diode current	I_S	T_C = 25 °C	-	-	187	A
Pulse diode forward current	I_{SM}		-	-	800	
Body diode voltage	V_{SD}	I_S = 10 A, V_{GS} = 0 V	-	0.68	1.1	V
Body diode reverse recovery time	t_{rr}	I_F = 10 A, di/dt = 100 A/µs, T_J = 25 °C	-	77	154	ns
Body diode reverse recovery charge	Q_{rr}		-	155	310	nC
Reverse recovery fall time	t_a		-	42	-	ns
Reverse recovery rise time	t_b		-	35	-	

Notes

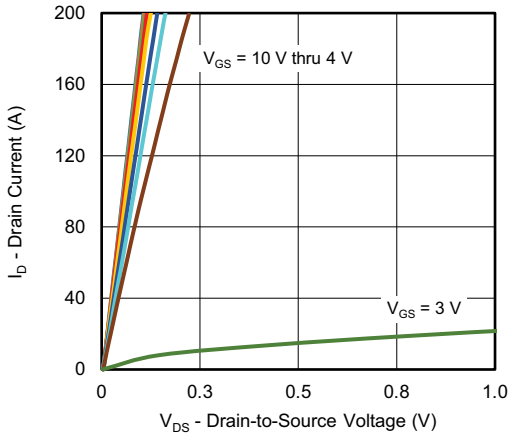
g. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %

h. Guaranteed by design, not subject to production testing

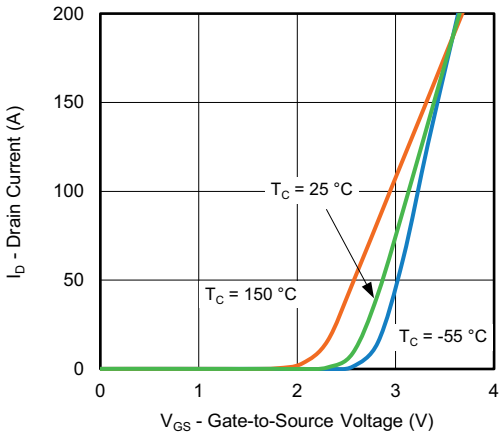
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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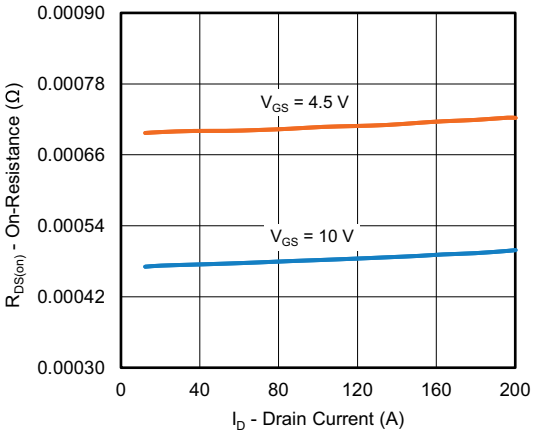
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



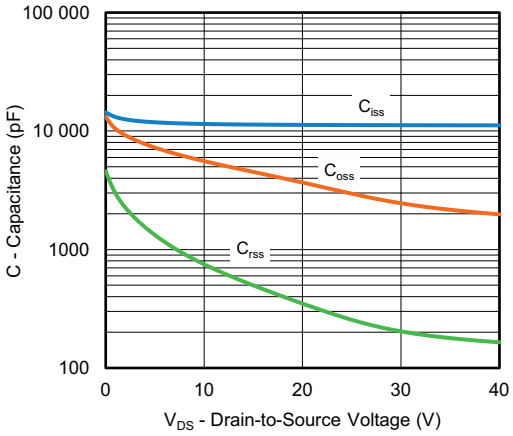
Output Characteristics



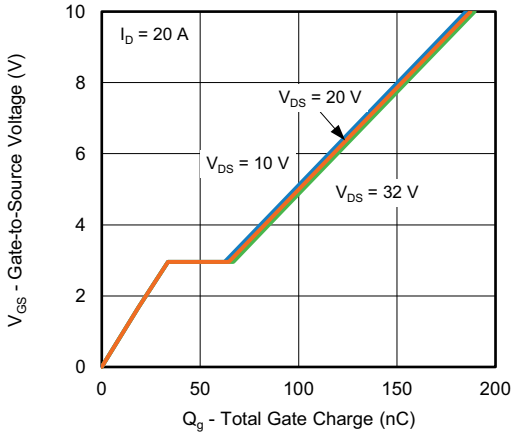
Transfer Characteristics



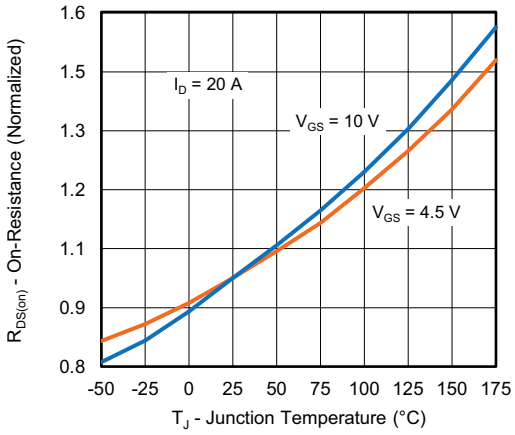
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



Gate Charge

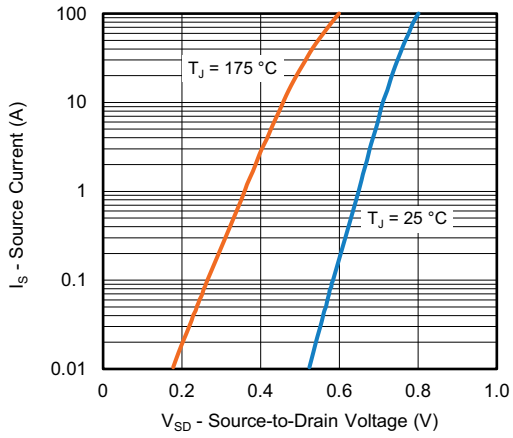


On-Resistance vs. Junction Temperature

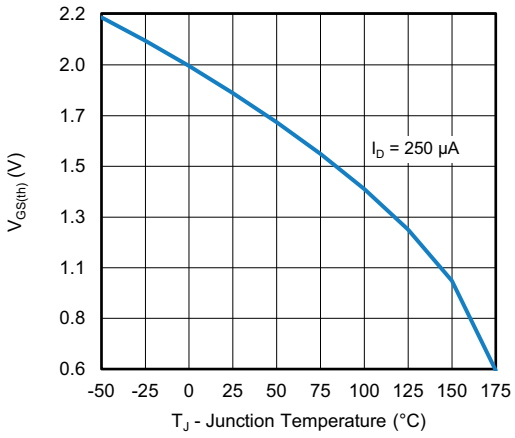
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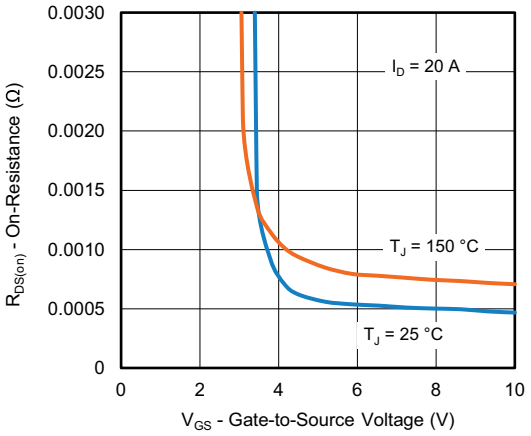
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



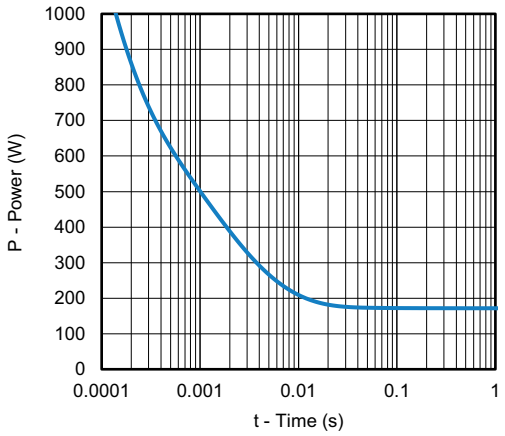
Source-Drain Diode Forward Voltage



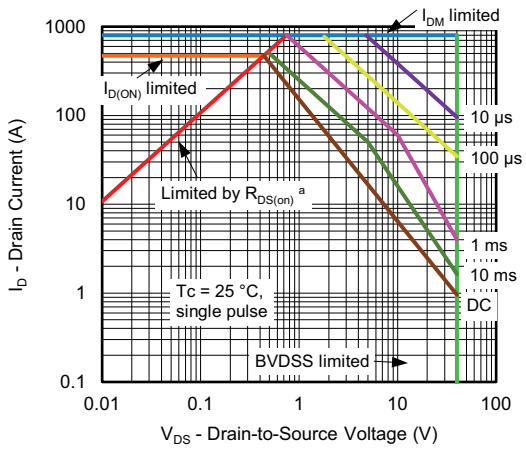
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Case



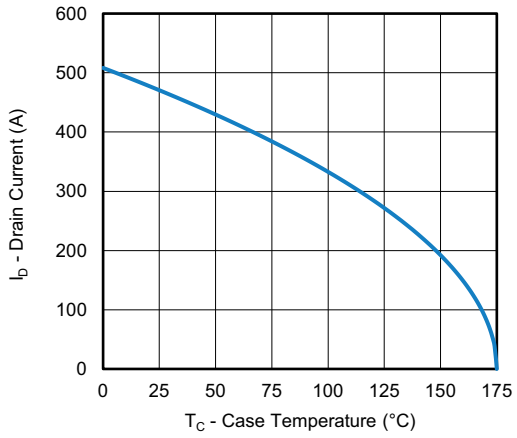
Safe Operating Area, Junction-to-Case

Note

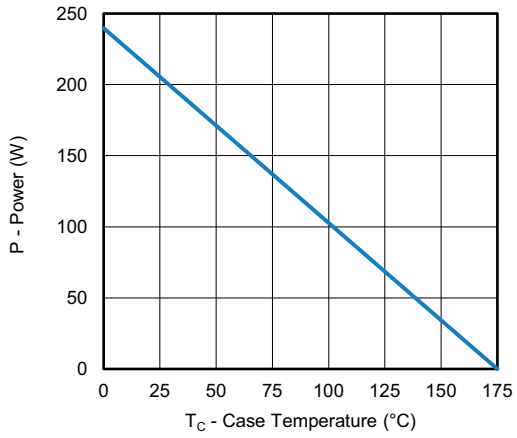
i. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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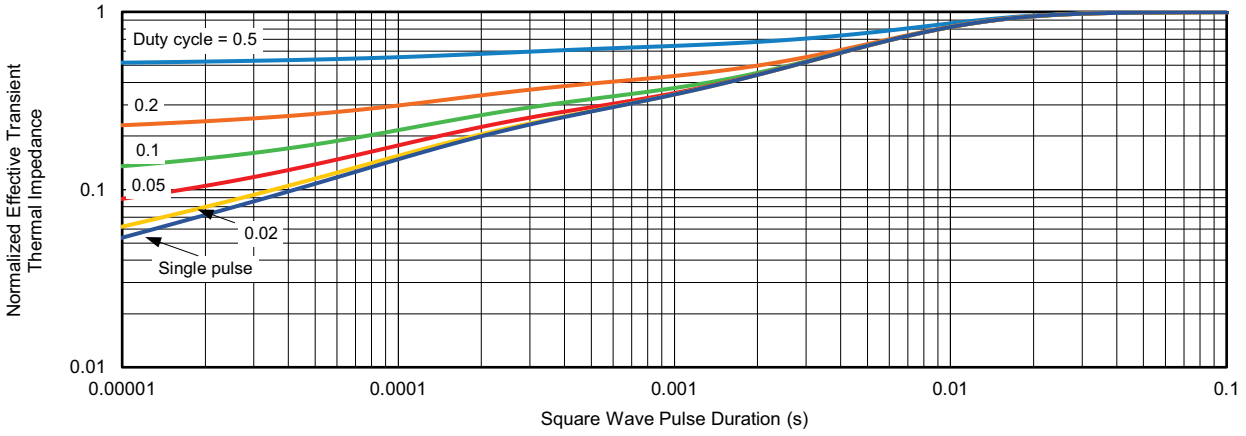
Current Derating [a]



Power, Junction-to-Case

Note

j. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

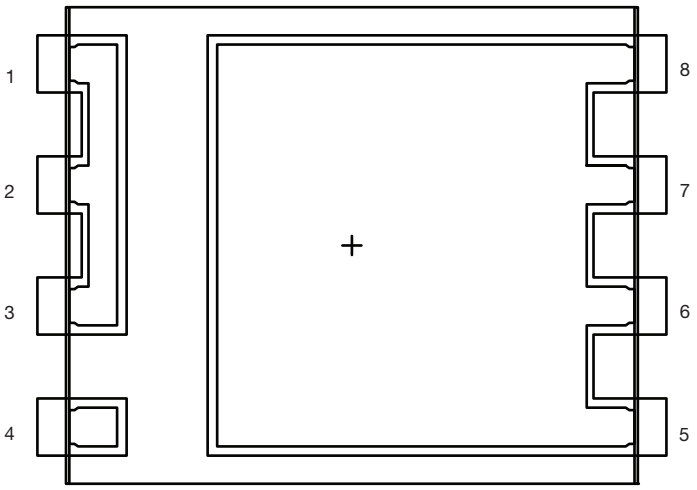


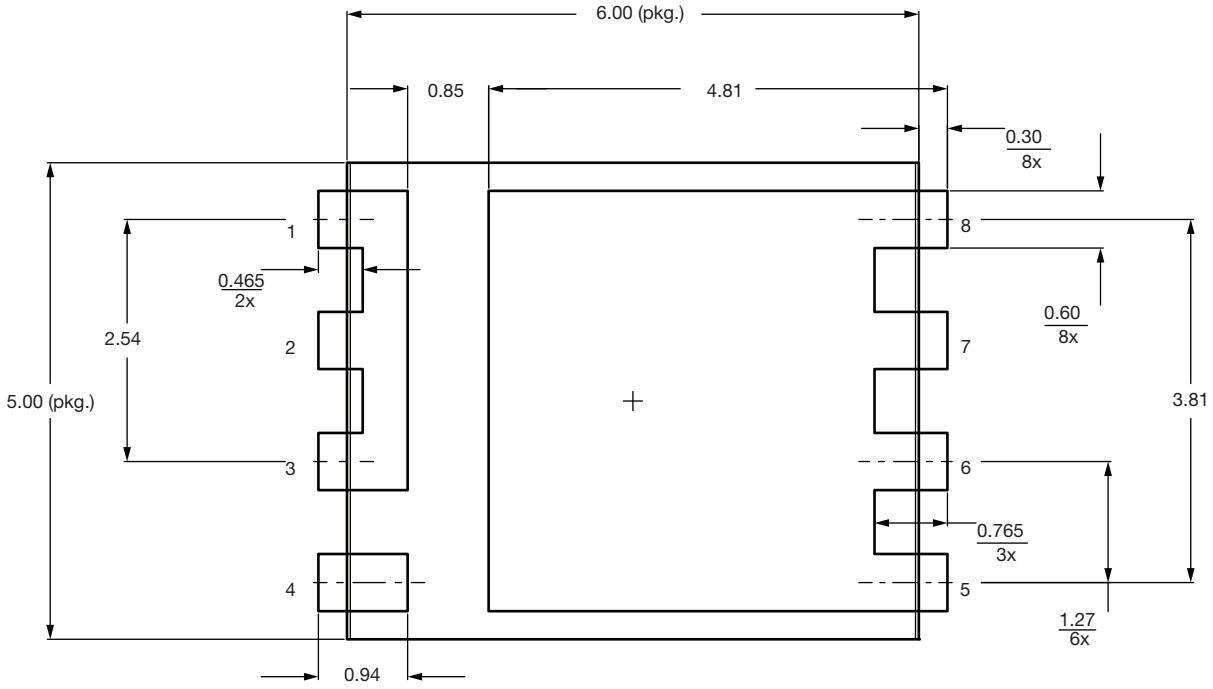
Normalized Thermal Transient Impedance, Junction-to-Case

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Recommended Land Pattern PowerPAK® SO-8SW (PKSO8SWSCL)





Note

- Dimensions in mm

ECN: C24-0483-Rev. A, 20-May-2024 DWG: 3027

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